



SamHop Microelectronics Corp.



STK400

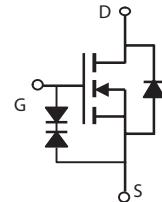
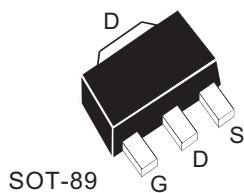
Ver 1.0

N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
40V	1.3A	390 @ V _{GS} =10V
		550 @ V _{GS} =4.5V

FEATURES

- Super high dense cell design for low R_{DSON}.
- Rugged and reliable.
- Surface Mount Package.
- ESD Protected.



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Symbol	Parameter		Limit	Units
V _{DS}	Drain-Source Voltage		40	V
V _{GS}	Gate-Source Voltage		±20	V
I _D	Drain Current-Continuous ^a	T _A =25°C	1.3	A
		T _A =70°C	1.0	A
I _{DM}	-Pulsed ^b		5.2	A
E _{AS}	Single Pulse Avalanche Energy ^d		0.25	mJ
P _D	Maximum Power Dissipation	T _A =25°C	1.25	W
		T _A =70°C	0.8	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range		-55 to 150	°C

THERMAL CHARACTERISTICS

R _{θ JA}	Thermal Resistance, Junction-to-Ambient	100	°C/W
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Details are subject to change without notice.

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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
I _{DS}	Zero Gate Voltage Drain Current	V _{DS} =32V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V , V _{DS} =0V			±10	uA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	1.8	3	V
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V , I _D =0.65A		300	390	m ohm
		V _{GS} =4.5V , I _D =0.55A		400	550	m ohm
g _{Fs}	Forward Transconductance	V _{DS} =5V , I _D =0.65A		1.4		S
DYNAMIC CHARACTERISTICS ^c						
C _{iss}	Input Capacitance	V _{DS} =20V,V _{GS} =0V f=1.0MHz		40		pF
C _{oss}	Output Capacitance			17.5		pF
C _{rss}	Reverse Transfer Capacitance			9.5		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =20V I _D =0.65A V _{GS} =10V R _{GEN} = 6 ohm		7.8		ns
t _r	Rise Time			11.2		ns
t _{D(OFF)}	Turn-Off Delay Time			105		ns
t _f	Fall Time			14		ns
Q _g	Total Gate Charge	V _{DS} =20V,I _D =0.65A,V _{GS} =10V		1.70		nC
		V _{DS} =20V,I _D =0.65A,V _{GS} =4.5V		1.15		nC
Q _{gs}	Gate-Source Charge	V _{DS} =20V,I _D =0.65A, V _{GS} =10V		0.42		nC
Q _{gd}	Gate-Drain Charge			0.61		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	V _{GS} =0V,I _s =0.7A		0.9	1.3	V
Notes						
a.Surface Mounted on FR4 Board,t ≤ 10sec.						
b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.						
c.Guaranteed by design, not subject to production testing.						
d.Starting T _J =25°C,L=0.5mH,V _{DD} = 20V.(See Figure13)						

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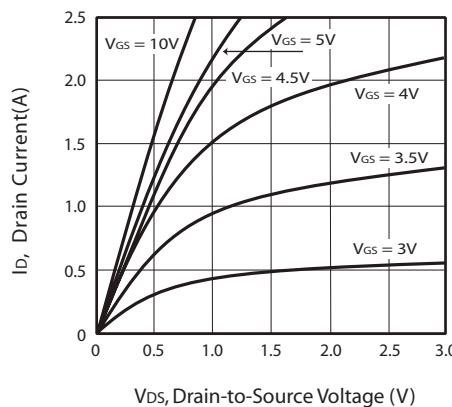


Figure 1. Output Characteristics

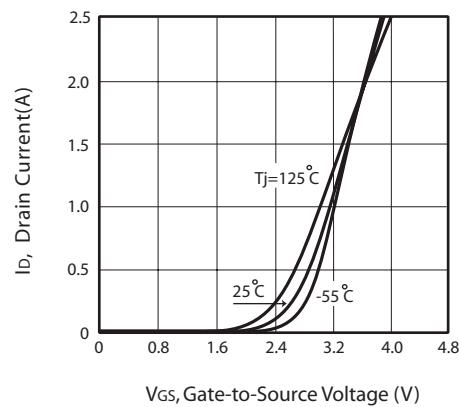


Figure 2. Transfer Characteristics

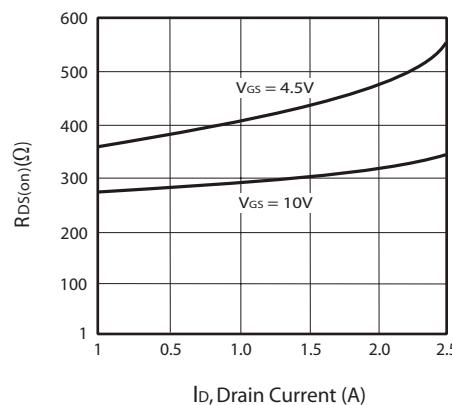


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

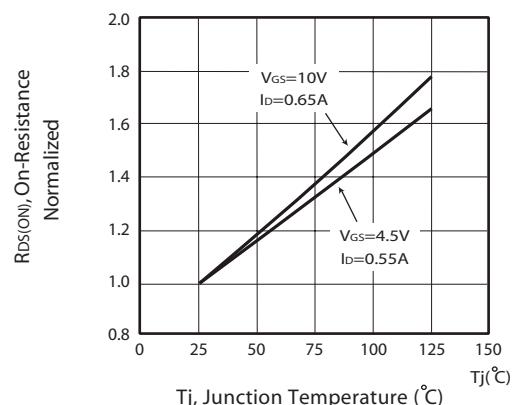


Figure 4. On-Resistance Variation with Drain Current and Temperature

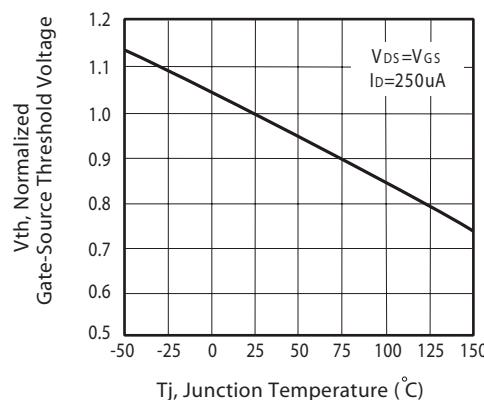


Figure 5. Gate Threshold Variation with Temperature

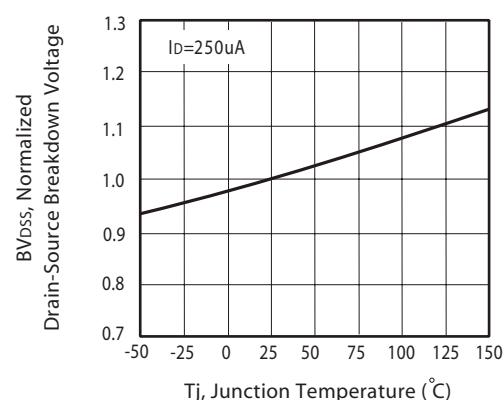


Figure 6. Breakdown Voltage Variation with Temperature

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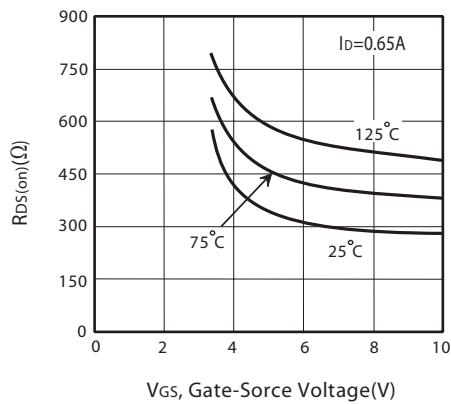


Figure 7. On-Resistance vs.
Gate-Source Voltage

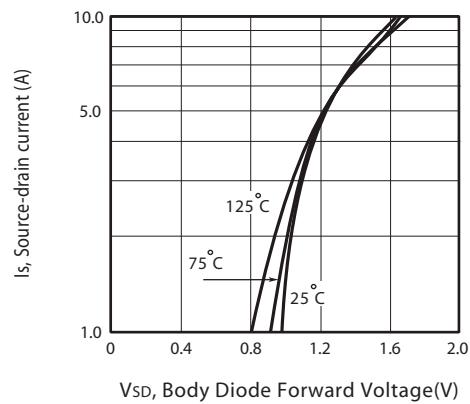


Figure 8. Body Diode Forward Voltage
Variation with Source Current

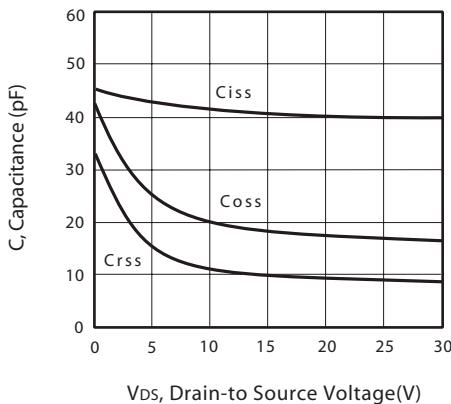


Figure 9. Capacitance

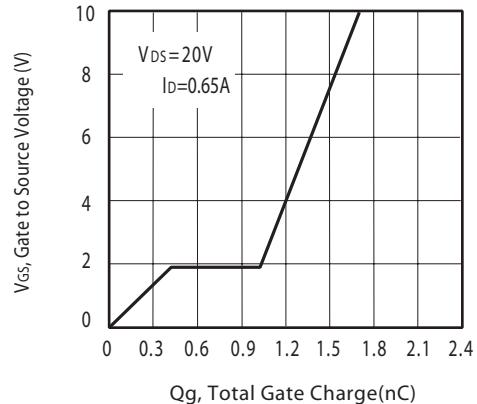


Figure 10. Gate Charge

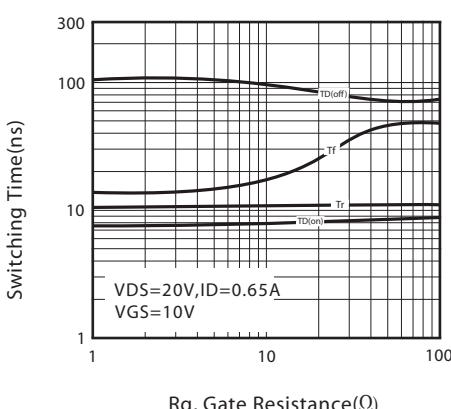


Figure 11. switching characteristics

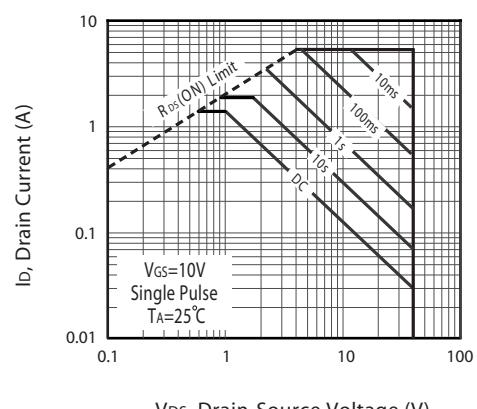
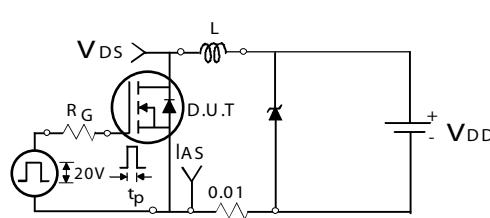


Figure 12. Maximum Safe
Operating Area

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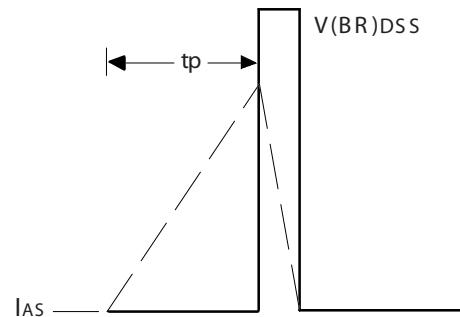
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

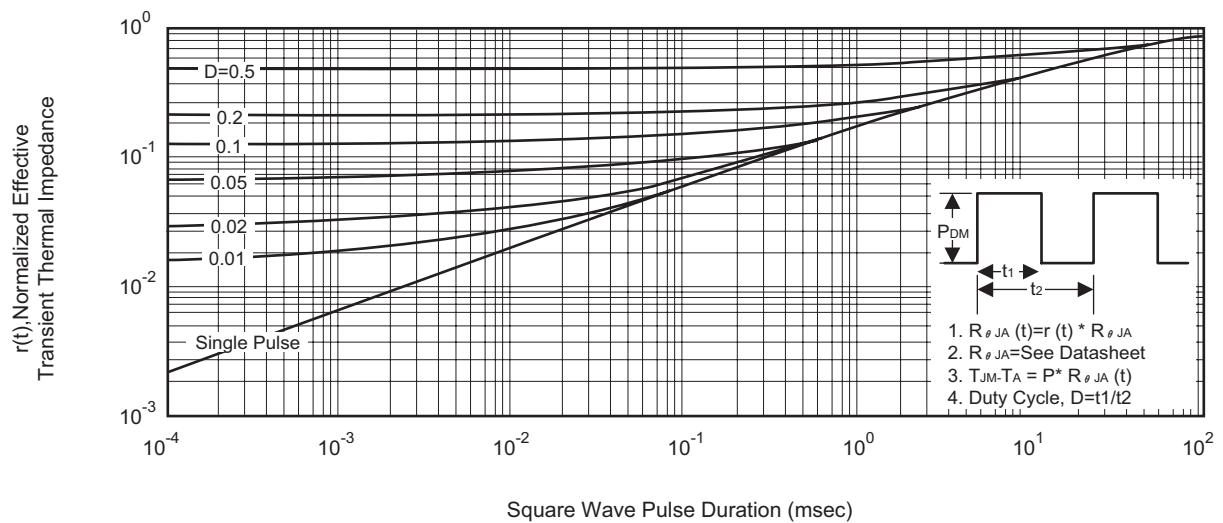
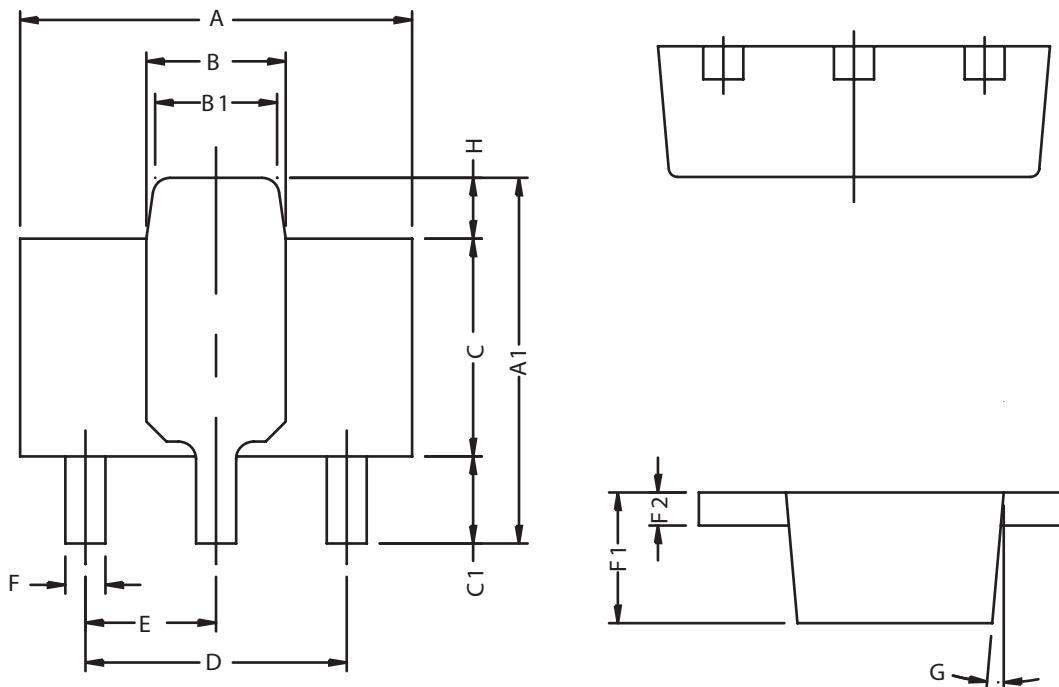


Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

SOT-89



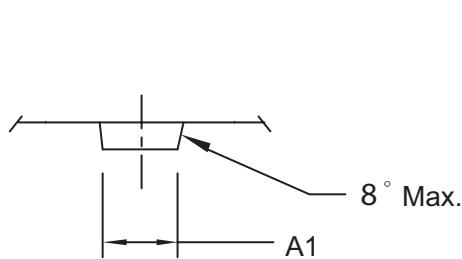
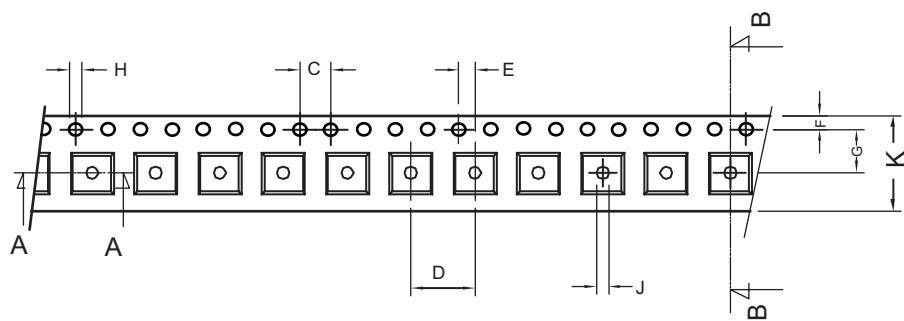
REF.	DIMENSIONS	
	Milimeters	
	MIN.	MAX.
A	4.40	4.60
A1	4.05	4.25
B	1.50	1.70
B1	1.30	1.50
C	2.40	2.60
C1	0.89	1.20
D	3.00	REF.
E	1.50	REF.
F	0.40	0.52
F1	1.40	1.60
F2	0.35	0.41
G	5° TYP.	
H	0.70	REF.

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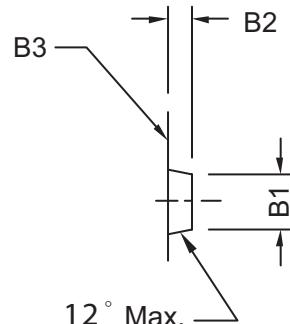
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SOT-89 Tape

SOT-89 Carrier Tape



SECTION A-A



SECTION B-B

unit:mm

PACKAGE	A1	B1	B2	C	D	E	B3	F	G	H	J	K	10C
SOP 8N 150mil	4.85 ± 0.10	4.45 ± 0.10	1.85 ± 0.10	4.0 ± 0.10	8.0 ± 0.10	2.0 ± 0.05	0.254 ± 0.02	1.75 ± 0.10	5.5 ± 0.05	1.50 ± 0.10	1.5 ± 0.25	12.0 $+0.30$ -0.10	40.0 ± 0.20

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